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Growth and characterisation of MnSb(0 0 0 1)/InGaAs(1 1 1)A epitaxial films


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ABSTRACT

MnSb layers have been grown on In0.46Ga0.54As(1 1 1) A virtual substrates using molecular beam epitaxy (MBE). The effects of both substrate temperature (Tsub) and Sb/Mn beam flux ratio (Jflx) were investigated. The surface morphology, layer and interface structural quality, and magnetic properties have been studied for a 3×3 grid of Tsub and Jflx values. Compared to known optimal MBE conditions for MnSb/GaAs(1 1 1) [Tsub = 415 °C, Jflx = 6.5], a lower substrate temperature is required for sharp interface formation when growing MnSb on In0.46Ga0.54As(1 1 1) A [Tsub = 350 °C, Jflx = 6.5]. At high flux ratio (Jflx = 9.5) elemental Sb is readily incorporated into MnSb films. At higher substrate temperatures and lower flux ratios, (In,Ga)Sb inclusions in the MnSb are formed, as well as MnAs inclusions within the substrate. The Sb and (In,Ga)Sb inclusions are epitaxial, while MnAs inclusions are endotaxial, i.e. all have a crystallographic relationship to the substrate and epilayer. MBE optimisation towards different device structures is discussed along with results from a two-stage growth scheme.

1. Introduction

The epitaxial combination of magnetic and semiconducting materials can underpin new spintronic device technologies with great potential for low-energy computation and data storage [1]. Two canonical spintronic devices are the spin valve and the spin field-effect transistor. For the latter in particular, In0.46Ga0.54As conducting channels are attractive, this material having high electron mobility and electron g-factor [2,3]. Transition metal monopnictides are materials that may be ideal for spintronic applications in combination with III-V semiconductor structures since they can be grown epitaxially by conventional molecular beam epitaxy (MBE) and have a wide variety of controllable magnetic properties.

Examples of transition metal monopnictide epitaxial growth on GaAs substrates include MnAs [4–6], CrAs [7], MnSb [8–10] and NiSb [11]. Compared to GaAs, rather fewer MBE growth studies have been carried out on In0.46Ga0.54As or related substrates. Amemiya et al. grew MnSb on an InGaAsP-based structure to fabricate a high-performance optical waveguide isolator [12]. Earul Islam and Akibori grew MnAs on InAs(1 1 1) B virtual substrates (grown on GaAs) [13] and fabricated a lateral spin valve showing a room temperature spin injection efficiency of approximately 8.5% and spin diffusion length of 0.7 μm [14]. Oomae et al. grew MnAs directly on InP, with the presence of the fully spin-polarized cubic B3 polymorph reported [15]. MnSb has been grown on In0.46Ga0.54As virtual substrates [16], a system for which a good lattice match can be achieved, and co-existence of cubic and hexagonal MnSb polymorphs was shown.

MnSb is a ferromagnetic material with high Curie temperature (589 K) which can be grown by MBE on a variety of semiconductor substrates [17–19]. The cubic B3 polymorph of MnSb is predicted to have robust half-metallicity (100% spin polarization at the Fermi level) even at room temperature [8], with high spin polarisation retained at III-V interfaces [20]. The stable hexagonal B8f polymorph (niccolite structure) is predicted to have enhanced spin polarisation at III-V interfaces [21]. In all cases the electrical conductivity is much lower than typical 3d transition metals, which can help to alleviate the well-known conductivity mismatch problem [22].

Our group has previously investigated the formation of both the niccolite and cubic MnSb polymorphs (n-MnSb and c-MnSb) on In0.46Ga0.54As(1 1 1) virtual substrates [16]. In this paper we present a detailed MBE growth study aimed at gaining a better understanding of this material system. The study explores the parameter space of MBE growth conditions for MnSb on In0.46Ga0.54As(1 1 1) A, focussing on substrate temperature and flux ratio Jflx calculated from beam equivalent pressures (BEP). Characterization was performed using in situ reflection high energy electron diffraction (RHEED), as well as ex situ

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atomic force microscopy (AFM), scanning electron microscopy (SEM), scanning transmission electron microscopy with energy dispersive X-ray spectroscopy (STEM and EDX), X-ray diffraction (XRD) and vibrating sample magnetometry (VSM).

2. Experimental details

MnSb layers were grown on In$_{0.48}$Ga$_{0.52}$As(1 1 1) A virtual substrates, which consist of 400 nm (In,Ga) As(1 1 1) on GaAs(1 1 1), via co-deposition of Mn and Sb. The XRD reported below gives an out-of-plane lattice parameter consistent with a virtual substrate composition of In$_{0.48}$Ga$_{0.52}$As, neglecting residual epitaxial strain. Virtual substrate growth has been detailed previously [16]. The fixed Mn flux and deposition time correspond to approximately 120 nm thick MnSb films grown at 2 nm/min. and growth was initiated by opening Mn and Sb cells simultaneously. A 3 × 3 grid of substrate temperatures ($T_{\text{sub}}$ = 350, 415, 450 °C) and flux ratios ($J_{\text{Sb}}/J_{\text{Mn}}$ = 3.5, 6.5, 9.5) was investigated. All samples were grown using a dedicated home-built MBE system which has shuttered Mn and Sb effusion cells, a retractable beam flux gauge and an electron gun with phosphor screen to allow in situ RHEED measurements (beam energy 12.5 keV). The Sb cell had no cracker stage and no As cell was fitted.

In$_{0.48}$Ga$_{0.52}$As(1 1 1) A samples approximately 8 mm × 8 mm were mounted onto stainless steel sample plates using spot-welded tantalum wires. These were ultrasonicated and rinsed with a series of solvent washes (acetone, isopropanol, and then deionised water). After cleaning the samples were blown dry with nitrogen and loaded immediately into the MBE vacuum system. Once transferred into the preparation chamber all of the samples were cleaned by annealing at 425 °C for 1 h, followed by argon ion bombardment for 8 min at 500 eV, and then annealing at 490 °C for 1 h. Argon ion sputtering and annealing may produce both enhanced n-type doping near the Mn/Sb/Mn interfaces simultaneously. A 3 × 3 grid of substrate temperatures ($T_{\text{sub}}$ = 350, 415, 450 °C) and flux ratios ($J_{\text{Sb}}/J_{\text{Mn}}$ = 3.5, 6.5, 9.5) was investigated. All samples were grown using a dedicated home-built MBE system which has shuttered Mn and Sb effusion cells, a retractable beam flux gauge and an electron gun with phosphor screen to allow in situ RHEED measurements (beam energy 12.5 keV). The Sb cell had no cracker stage and no As cell was fitted.

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3. Results

3.1. RHEED

The surface preparation procedure for the virtual substrates produced an ordered In$_{0.48}$Ga$_{0.52}$As(1 1 1) A surface with (2 × 2) periodicity. We did not attempt to determine this reconstruction quantitatively, but it is most likely a “missing Ga(In)” structure by comparison to the (2 × 2) found both on GaAs(1 1 1) A [25] and InAs(1 1 1) A surfaces [26]. A small selection of example RHEED patterns obtained after MnSb growth is shown in Fig. 1, with the lower section showing example patterns of the individual features. Examples along both principal surface azimuths are shown, namely (1 1 0) [A and C, both showing (1 × 1) periodicity) and (1 0 0) [E and D, both showing (2 × 2) periodicity]. A sharp (2 × 2) periodicity with higher Laue zones and Kikuchi features was present for all samples grown with $J_{\text{Sb}}/J_{\text{Mn}}$ = 6.5. Previous work on B$_1$ structured MnSb(0 0 1) has shown that this surface reconstruction is associated with smooth and well-ordered MnSb surfaces [27,28]. For $J_{\text{Sb}}/J_{\text{Mn}}$ = 6.5 samples grown with $T_{\text{sub}} \geq 415$ °C, very faint incommensurate transmission spots were present (example E). Their spacing in the RHEED pattern corresponds to a material with an in-plane lattice parameter of 4.54 Å, approximately 10% larger than n-MnSb.

The use of the high flux ratio $J_{\text{Sb}}/J_{\text{Mn}}$ = 9.5 formed a (1 × 1) surface reconstruction occasionally showing very faint fractional-order streaks. Transmission spots consensurate with the integer order surface streaks were present for growth at $T_{\text{sub}}$ = 350 °C and 415 °C, but these were absent for two-stage growth and for $T_{\text{sub}}$ = 450 °C (example C). Only the lowest-order Laue zone was present in the RHEED patterns, and Kikuchi lines were not present, for the low growth temperature of $T_{\text{sub}}$ = 350 °C at $J_{\text{Sb}}/J_{\text{Mn}}$ = 9.5 (example A). For MBE growth conditions using a low flux ratio of $J_{\text{Sb}}/J_{\text{Mn}}$ = 3.5 the RHEED patterns became very weak, with the higher temperatures $T_{\text{sub}} \geq 415$ °C producing only faint and modulated streaks. Neither higher Laue zones nor Kikuchi lines were present in RHEED patterns from any single-stage MnSb layers grown at $J_{\text{Sb}}/J_{\text{Mn}}$ = 3.5. The two-stage growth produced a slight improvement, with a (2 × 2) periodicity present alongside incommensurate transmission spots. Overall, RHEED patterns of the best quality were observed for $J_{\text{Sb}}/J_{\text{Mn}}$ = 6.5. We now turn to ex situ measurements to understand this behaviour in more detail.

![Fig. 1. RHEED pattern summary (upper panel) and examples (lower panels) for MnSb growth on InGaAs(1 1 1) A as a function of substrate temperature $T_{\text{sub}}$ and Sb/Mn flux ratio $J_{\text{Sb}}/J_{\text{Mn}}$. Patterns A, C, and E exemplify the main features observed in the two principal surface azimuths, and line profiles across each pattern are also shown. Red lines indicate the integer streak positions for each pattern. (For interpretation of the references to colour in this figure legend, the reader is referred to the web version of this article.)](image-url)
3.2. SEM and AFM

Imaging by SEM at low magnification showed clearly that crystallites ranging between 0.1 µm and 1 µm in diameter were formed on the surface during growth for all samples. Example crystallites are circled in red (Fig. 2a). The vertical extent of individual crystallites increased with higher $J_{Sb/Mn}$, which suggests that the crystallites are capturing excess Sb and are therefore likely formed of MnSb$_2$ or Sb. They appear too large to contribute to transmission diffraction in RHEED, and not flat enough to contribute to surface diffraction, and so probably act to increase the diffuse background in the patterns. The areal surface densities of these crystallites measured from each growth condition, for both single-stage and two-stage growth methodology, are shown in Fig. 2b (error bars estimated assuming Poisson statistics). This analysis shows that $J_{Sb/Mn} = 6.5$ leads to higher quality surfaces with fewer crystallites forming, and that these areal densities are decreased using a two-stage growth method.

Example AFM images are shown in Fig. 3. Samples grown using either the single-stage or two-stage method exhibit similar trends in surface morphology and only single-stage are shown for clarity. At flux ratios $J_{Sb/Mn} > 6.5$ some step-terrace structure can be observed, a broadly isotropic mesa-like pattern. Additional islands and pits can be observed, especially at higher temperatures for $J_{Sb/Mn} = 6.5$. These island features are much smaller and higher density than the crystallites observed by SEM and are good candidates for transmission diffraction in RHEED. The crystalline film structure is clearest for $J_{Sb/Mn} = 6.5$ and $T_{sub} = 350°C$, where hexagonal mesas are formed on the surface which are approximately 400 nm in width and 10–15 nm in height. The edges of the hexagonal features show good mutual alignment indicating that these structures are epitaxially related to the substrate. All films deposited using $J_{Sb/Mn} = 3.5$ showed a more disrupted surface with much higher peak-to-peak heights. Both pits and islands are more prevalent and no clear hexagonal structure is observed.

Root mean square (RMS) roughness values calculated from $1 \mu m \times 1 \mu m$ images for these growth conditions are summarised in Fig. 4. The surfaces were much rougher for Sb-poor growth with $J_{Sb/Mn} = 3.5$ due to the high density of pits and islands. Under Sb-rich conditions, $J_{Sb/Mn} = 9.5$, roughness was dominated by the hexagonal mesa-like undulations. Both the single stage and two stage growth method produced films with the lowest RMS values when grown using

![Fig. 2](image_url) (a) An example SEM image with surface crystallites circled in red (b) areal densities of crystallites for all growth conditions. Shaded regions represent the error bars due to counting statistics. (For interpretation of the references to colour in this figure legend, the reader is referred to the web version of this article.)

![Fig. 3](image_url) AFM topographs ($5 \mu m \times 5 \mu m$) collected from single-stage growth samples over all growth conditions.
Fig. 4. RMS roughness values for single-stage and two-stage samples for all growth conditions, calculated from 1 μm x 1 μm AFM images.

\[ J_{350/415} = 6.5. \] The most uniform morphology and lowest RMS roughness was observed for single stage growth using \( J_{350/415} = 6.5 \) and \( T_{sub} = 415 \, ^\circ \text{C} \), with an RMS roughness value of 1.29 nm. RHEED, AFM and SEM all suggest that \( J_{350/415} = 6.5 \) is the optimum flux ratio for smooth and ordered MnSb films. By now considering STEM and EDX we can investigate the internal structure of the films.

3.3. STEM

Examples of STEM and EDX data collected from a representative set of single-stage samples is shown in Figs. 5 and 6. The result of MnSb growth at high and low \( J_{350/415} \) values is shown in Fig. 5, non-optimal values according to the discussion so far. For growth at \( J_{350/415} = 3.5 \) (Fig. 5a), the MnSb/In\(_{0.48}\)Ga\(_{0.52}\)As interface can readily be identified by the sharp boundaries in the Sb and As EDX maps. However, it is clear that there is considerable disruption below the interface due to strong intermixing of the metal species. Mn extends several tens of nm into the substrate, forming MnAs. This seems similar to endotaxial growth of MnSb previously observed on InP [24], GaP [29] and GaSb [30] substrates. In the other direction, Ga diffuses strongly through the MnSb film and In forms large interfacial clusters, displacing Mn. It therefore appears that In\(_{0.48}\)Ga\(_{0.52}\)_Sb inclusions are formed within the MnSb layer as well as MnAs due to strong exchange of metal species across the interface. The interfacial behavior is very different for growth at \( J_{350/415} = 9.5 \) (Fig. 5b). The STEM and EDX maps show an abrupt interface for all elements without strong intermixing of the metal species across the interface. There is still some Ga segregation through the MnSb film. However, the high Sb flux leads to the formation of Sb inclusions within the growing MnSb layer. These Sb inclusions do not incorporate any Mn, but do appear to attract some segregated Ga.

STEM from samples grown at \( J_{350/415} = 6.5 \) (Fig. 6) again show sharp interfaces between Sb-containing and As-containing regions. However, there is still intermixing of the metal species. From our STEM imaging, this appears to be mostly suppressed for \( T_{sub} = 350 \, ^\circ \text{C} \) (Fig. 6a) compared to \( T_{sub} = 415 \, ^\circ \text{C} \) (Fig. 6b). The formation of In\(_{0.48}\)Ga\(_{0.52}\)_Sb inclusions which reach the sample surface provides a possible explanation for the incommensurate transmission spots observed in RHEED patterns in the latter case. The estimated cubic lattice constant of \( \sqrt{2}(4.54) = 6.42 \, \text{Å} \) from RHEED would correspond to In\(_{0.48}\)Ga\(_{0.52}\)Sb. Taken together, the data suggest that at \( J_{350/415} = 6.5 \) the optimum substrate temperature for interface sharpness (around \( T_{sub} = 350 \, ^\circ \text{C} \)) is lower than that for surface smoothness (around \( T_{sub} = 415 \, ^\circ \text{C} \)).

The EDX analysis was quantified for several areas imaged by STEM. An example is given in the left panel of Fig. 6b and Table 1, for the sample grown using \( T_{sub} = 415 \, ^\circ \text{C} \) and \( J_{350/415} = 6.5 \). The values of EDX analysis presented in Table 1 correspond to the numbered areas in the figure. Area 2 comprises In\(_{0.48}\)Ga\(_{0.52}\)_Sb with similar In and Ga fraction x, but also with Mn intermixed, while areas 1 and 3 are predominantly MnSb but with Ga intermixed. These areas are all above the nominal epilayer/substrate interface, and show some additional As segregation. Below the interface, areas 4 and 5 are predominantly MnAs containing a significant fraction of Ga. Areas 6 and 7 are close to the nominal In\(_{0.48}\)Ga\(_{0.52}\)As stoichiometry. These data confirm the strong In-Ga/Mn

![Fig. 5. Cross-sectional STEM and accompanying EDX maps taken from samples deposited with (a) \( J_{350/415} = 3.5 \) and \( T_{sub} = 415 \, ^\circ \text{C} \) (b) \( J_{350/415} = 9.5 \) and \( T_{sub} = 350 \, ^\circ \text{C} \). The color intensity represents the elemental concentration, with black equating to none of the element being present. (For interpretation of the references to colour in this figure legend, the reader is referred to the web version of this article.)](image1)

![Fig. 6. Cross-sectional STEM and accompanying EDX images taken from samples deposited at \( J_{350/415} = 6.5 \) with \( T_{sub} = (a) 350 \, ^\circ \text{C} \) and (b) 415 \, ^\circ \text{C} \).](image2)

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3.4. XRD

Having demonstrated the presence of Sb, MnAs and In\textsubscript{1-x}Ga\textsubscript{x}Sb in nominally MnSb/In\textsubscript{0.48}Ga\textsubscript{0.52}As samples we now examine XRD data to determine if these inclusions are crystallographically aligned. Symmetric out-of-plane $\theta$−2$\theta$ XRD scans collected from across the whole 3×3 grid are shown in Fig. 7. Strong Bragg peaks from the virtual substrate materials are present in all scans. The expected B8\textsubscript{1} MnSb(0002) epilayer peak is present in all samples with $J_{\text{Sb/Mn}} \geq 6.5$. For single-stage growth at $J_{\text{Sb/Mn}} = 3.5$ a weak MnSb(0002) feature is present only for $T_{\text{sub}} = 350^\circ$C. At higher temperatures for this flux ratio, no MnSb(0002) peak is discernible. However, a clear MnSb(1101) feature is present. Weaker MnSb(1101) peaks are observed for the other growth conditions as well; such non-(0 0 0 1) orientations have been observed for both NiSb and MnSb growth on GaAs(1 1 1)\textsuperscript{[11,16]} but were not previously seen for MnSb on In\textsubscript{0.5}Ga\textsubscript{0.5}As(1 1 1)\textsuperscript{[16]}. The MnSb(0002) peak for samples grown using $J_{\text{Sb/Mn}} = 9.5$ could be fitted with a single Pearson VII function (fits are not shown for clarity), with centroid corresponding to out-of-plane lattice parameters in the range 5.7948–5.7955 Å. These values are around 0.1% larger than the reported bulk c lattice parameter of 5.789 Å. This may reflect compressive in-plane stress due to Sb inclusions.

In contrast to single-component fits to MnSb(0 0 0 2) peaks at $J_{\text{Sb/Mn}} = 9.5$, for $J_{\text{Sb/Mn}} = 6.5$ a minimum of two components was required. The use of two fitting components indicates that there are two distinct out-of-plane strain states of MnSb present for the samples grown at $J_{\text{Sb/Mn}} = 6.5$. Note that for $T_{\text{sub}} = 350^\circ$C this second strain state appears at higher $Q_z$ (up to $-0.4$% out-of-plane lattice compression), whereas intermixing taking place at the higher substrate temperatures.
for $T_{\text{sub}} \geq 415 \, ^\circC$ it appears at lower $Q_z$ (up to $+0.6\%$ out-of-plane lattice expansion). This suggests that there are different mechanisms driving the formation of multiple strain states in the MnSb which depend on growth conditions. For $T_{\text{sub}} \geq 415 \, ^\circC$, the presence of In$_{1-x}$Ga$_x$Sb within the epilayer may produce local compressive in-plane stress leading to out-of-plane expansion, in a similar manner to the Sb inclusions. However, these explanations remain speculative: selected area electron diffraction may help to elucidate the mechanisms.

All of the samples show additional peaks at lower $Q_z$ values ($Q_z < 1.74 \, \AA^{-1}$) which can be readily assigned to the inclusions observed by STEM-EDX, and show that at least a fraction of the inclusions are epitaxially oriented. For all samples grown with $J_{\text{sub}}/M_{\text{Sb}} \leq 6.5$ the low-$Q_z$ features are due to combinations of signals from InSb(111) and In$_{1-x}$Ga$_x$Sb(11 1). These features provide an insight into the surface segregation behaviour of the metallic species. It can be seen that Ga segregation is suppressed through the use of a decreased substrate temperature, with only the InSb(1 1 1) peak present in both $T_{\text{sub}} = 350 \, ^\circC$ samples. These InSb(1 1 1) peaks also show a decrease in intensity, indicating decreased In segregation, with an increase in J value. However for the single-stage samples with the high value of $J_{\text{sub}}/M_{\text{Sb}} = 9.5$, a clear peak at $Q_z = 1.67 \, \AA^{-1}$ is assigned to hexagonal Sb (1 1 1). These results show the potential for simultaneously suppressing both the segregation of In and the formation of Sb inclusions through the use of an intermediate $J_{\text{sub}}/M_{\text{Sb}}$ value ($6.5 < J_{\text{sub}}/M_{\text{Sb}} < 9.5$).

For two-stage samples (Fig. 7b) MnSb(0002) Bragg peaks were present at all $J_{\text{sub}}/M_{\text{Sb}}$ values. The diffractograms for all three $T_{\text{sub}}$ values are identical at $J_{\text{sub}}/M_{\text{Sb}} = 9.5$ and we would hence expect the two-stage growth at $J_{\text{sub}}/M_{\text{Sb}} = 9.5$ to look the same. This is indeed the case, with a broad Sb(111) peak appearing at $Q_z \approx 1.67 \, \AA^{-1}$ due to epitaxial Sb inclusions. However, the two-stage procedure has clearly not completely suppressed segregation of the metal species from the substrate at $J_{\text{sub}}/M_{\text{Sb}} \leq 6.5$, since clear In$_{1-x}$Ga$_x$Sb(1 1 1) peaks still appear at $Q_z \approx 1.72 \, \AA^{-1}$. The low temperature growth layer is only around 2 nm thick, clearly smaller than the segregation length scales observed by STEM. Nonetheless, the low temperature stage has not introduced detectable Sb inclusions and the two-stage growth process does improve the crystallinity of the MnSb at low flux ratio. The MnSb(0 0 0 2) peak is much better defined and there is much less evidence of MnAs formation at $J_{\text{sub}}/M_{\text{Sb}} = 3.5$ compared to the single-stage growths at $T_{\text{sub}} = 350 \, ^\circC$ and $415 \, ^\circC$. This improvement, and the reduced crystallite density (Fig. 2), may be due to the growth interrupted as part of the two-stage procedure. A longer low-temperature stage and/or a longer growth interruption may reduce Ga and In segregation without introducing unacceptable Sb inclusion.

The peak observed at $Q_z \approx 2.31 \, \AA^{-1}$ for $J_{\text{sub}}/M_{\text{Sb}} = 3.5$ and $T_{\text{sub}} = 350 \, ^\circC$ or $415 \, ^\circC$, is attributed to B$_1$ structured MnAs(0 0 0 2). Together with the STEM-EDX results, this shows that the MnAs formed under these conditions is indeed endotaxial, i.e. crystallographically oriented but below the original substrate surface. Although some MnAs formation is observed by STEM-EDX for $J_{\text{sub}}/M_{\text{Sb}} = 6.5$ (Fig. 6b) it is clearly either too small in grain size to produce a diffraction feature or is not epitaxial.

3.5. VSM

VSM measurements taken from three representative growth conditions are shown in Fig. 8 in the form of M-H loops. All loops were collected at 10 K, with the applied field aligned in the plane of the sample. The hysteresis loops shown in Fig. 8a had the diamagnetic response of the substrate removed.

Comparing the 3 samples, it is clear that the sample deposited using $J_{\text{sub}}/M_{\text{Sb}} = 3.5$ shows significantly degraded magnetic properties (Fig. 8a), with a much lower overall saturation magnetization and a larger coercive field. This is consistent with the high degree of disruption of the low-$J_{\text{sub}}/M_{\text{Sb}}$ films observed and the presence of large non-magnetic inclusions. The two samples grown using $J_{\text{sub}}/M_{\text{Sb}} = 6.5$ are much more similar in saturation magnetization, as expected, but a closer comparison shows clear differences. The $T_{\text{sub}} = 350 \, ^\circC$ sample has a lower coercive field (Fig. 8b), correlating with the STEM findings which showed it has the lowest level of intermixing in the MnSb layer. This sample also exhibits steps in its M-H loop (Fig. 8c) which is present on both the up and down sweeps of the scan. These steps may be caused by the magnetic switching of hexagonal domains observed in AFM and SEM, where differently sized domains switch magnetic orientation at different applied fields.

Volumes of the MnSb layers were calculated using thickness measurements (obtained from TEM images) along with macroscopic area measurements. These volumes allowed magnetisations per Mn atom to be calculated for all three $[T_{\text{sub}}, J_{\text{sub}}/M_{\text{Sb}}]$ conditions, assuming the ideal niccolite structure for the whole MnSb layer. The magnetisations of the three films were $1.2 \pm 0.1 \mu$B for [415 °C, 3.5], $2.4 \pm 0.2 \mu$B for [415 °C, 6.5] and $3.7 \pm 0.4 \mu$B for [350 °C, 6.5]. Out of the three samples measured only the growth condition using $T_{\text{sub}} = 350 \, ^\circC$ gave a magnetisation in agreement with the published bulk value of 3.5 µB per Mn atom [31]. The low magnetisation per Mn atom for both films grown at 415 °C agree with the observations of film intermixing presented earlier. These magnetometry results show that the likely optimum temperature for thin film magnetic properties may be somewhat lower for MnSb on In$_{0.5}$Ga$_{0.5}$As(1 1 1) than for MnSb on GaAs(111) (400–420 °C).

4. Discussion and conclusions

An explanation previously suggested for the formation of GaSb inclusions during MnSb/GaAs(1 1 1) epitaxy is that surface preparation of the substrate by argon ion sputtering and annealing leaves metallic Ga nano-clusters which readily take up excess Sb during MnSb growth [16,24]. This does not seem to be applicable here: In$_{0.5}$Ga$_{0.5}$Sb growth appears to be too suppressed by high Sb flux which is not what one would not expect if metal droplets were already present on the substrate surface. The In and Ga segregation observed is therefore attributed to diffusion processes, and not to the surface preparation. An important question is whether the metal exchange reaction is thermodynamically favorable. Using estimated enthalpies of formation for Mn (As,Sb) [32] and In$_{0.5}$Ga$_{0.5}$As(As,Sb) [33] the simple exchange reaction has a small energy cost: the formation enthalpy of In$_{0.5}$Ga$_{0.5}$As + MnSb is $-108.9 \, \text{kJ mol}^{-1}$ while that for In$_{0.5}$Ga$_{0.5}$Sb + MnSb is $-105.0 \, \text{kJ mol}^{-1}$. A simple thermodynamic argument was used to explain trends in surface reactivity for Mn deposition on different GaAs and InSb reconstructed surfaces [34], but in that case there was no incident group V flux and the temperature was fixed. In the present case the Sb flux clearly has a powerful influence in determining the degree of metal exchange and group V kinetics cannot be neglected. Furthermore both strain and surface energies must surely play a role and a predictive model for endotaxial growth of transition metal monopnicrides remains to be developed.

A multi-technique study has been performed for the MBE growth of MnSb on In$_{0.45}$Ga$_{0.55}$As(1 1 1) A substrates, employing RHEED, AFM, SEM, STEM, EDX, XRD and VSM. A 3 x 3 grid of beam flux ratios $J_{\text{sub}}/M_{\text{Sb}}$ and substrate temperatures $T_{\text{sub}}$ has been studied. The flux ratio is critical and a balance must be struck between incorporating epitaxial Sb (high $J_{\text{sub}}/M_{\text{Sb}}$) and allowing the exchange of metal species (mid $J_{\text{sub}}/M_{\text{Sb}}$), while growth in Mn-rich conditions (low $J_{\text{sub}}/M_{\text{Sb}}$) causes heavy disruption of the substrate with endotaxial MnAs growth and poor MnSb films. At $J_{\text{sub}}/M_{\text{Sb}} = 6.5$ the optimum substrate temperature for growth appears to be lower than that used for growth on GaAs. In particular, interface sharpness is best at around $T_{\text{sub}} = 350 \, ^\circC$ while surface smoothness is best at around $T_{\text{sub}} = 415 \, ^\circC$, and the coercive field improves when dropping from 415 °C to 350 °C. This suggests an overall optimum growth temperature between the two, i.e. rather lower than for growth on GaAs(1 1 1), but even at such a temperature it is not clear that both sharp interfaces and smooth, Sb inclusion-free films would be grown.
A simple two-stage growth method was employed to try to balance interface and surface smoothness, growing 2 nm of material at low $T_{\text{sub}} = 350^\circ \text{C}$ before interrupting growth and raising to $T_{\text{sub}} = 415^\circ \text{C}$. This reduced the density of surface crystallites, which were observed for all growth conditions, ranging in size between 0.1 µm and 1 µm. Furthermore the endotaxial growth of MnAs at low flux ratio was suppressed. However, the segregation of In and Ga from the substrate was not fully inhibited at the optimum flux ratio, which suggests that the MnSb overlayer is still incomplete at this stage (i.e. the morphology comprises disconnected islands). Hence a longer low-temperature growth stage and/or a growth interrupt may be useful, in order to allow the thin MnSb layer to fully cover the substrate and suppress In and Ga segregation. The growth interrupt itself may also be beneficial independently of the change of $T_{\text{sub}}$. It should be noted that the electrical properties of semimetallic MnSb should not be degraded by adsorption of a small fraction of a monolayer of contaminants, as might occur with a doped semiconductor material undergoing a long growth interrupt.

The goals of MBE growth optimization depend on the device structures targeted. For spin transport applications, the quality of the semiconductor/ferromagnet interface is generally thought to be most important. For a typical lateral spin valve structure, since metal contacts would subsequently be formed on the MnSb pads, its surface smoothness is not critical. Furthermore, in the present study the Sb inclusions do not appear to contact the interface where they would provide a non-spin polarized parallel conduction pathway. Finally a significant size or shape anisotropy difference between contacts is often used to allow switching of a single contact by an external field, and in such a case slightly non-optimal magnetic response may be tolerated. These considerations point towards lower MnSb growth temperatures.

For applications where the magnetic saturation, coercivity and anisotropy of the MnSb films is more important, such as waveguide optical isolators [12] or micromagnetic structures, a poorer interface may be tolerated. This work suggests that further MBE growth studies for MnSb growth on In$_{0.5}$Ga$_{0.5}$As, where interfacial intermixing is a particular challenge, should move beyond substrate temperature/flux ratio optimization to consider longer low-temperature growth stages and/or a growth interrupt early into the MnSb layer growth with the aim of fully suppressing In and Ga segregation.

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References


